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Applicant:

Hong Yang, et al.

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FABRICATION OF CERAMIC MICROSTRUCTURES

Examiner:

Christopher A. Fiorilla

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## CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

The undersigned hereby certifies that this document is being placed in the United States mail with first-class postage attached, addressed to MAIL STOP AMENDMENT, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the 4th day of May, 2005.

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Signature

## MAIL STOP AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## **AMENDMENT**

Sir:

In response to the Office Action mailed January 24, 2005, Applicants respectfully request reconsideration in view of the following remarks:

The Claims are reflected in the listing of claims that begins on page 2 of this response.

Remarks begin on page 8 of this response.